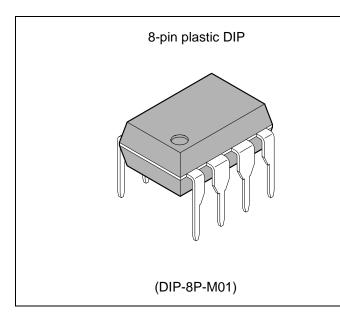
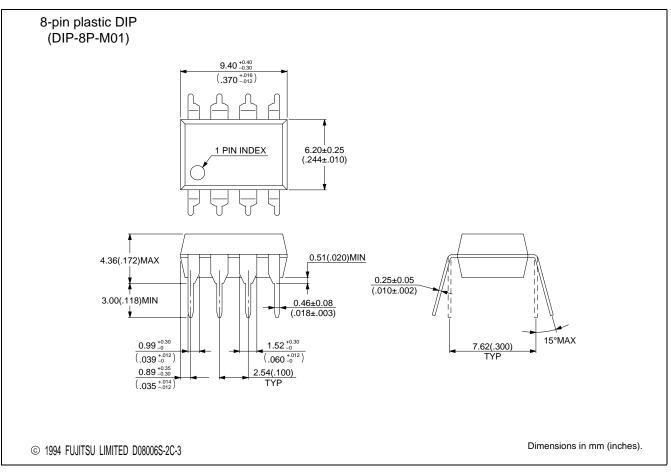
DIP-8P-M01



EIAJ CODE :*DIP008-P-0300-1	
Lead pitch	100 mil
Row spacing	300 mil
Sealing method	Plastic mold



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